COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE
BOARD #: TIDA-00702
REVISION: RevB
SUN REV: Not In VersionControl

IGINRE -> M5 Assembly Top

PLOT NAME = Top Assembly Drawing
GENERATED: 12/3/2015 5:28:54 PM
TExAS INSTRUmenTS
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